



S/10/634,274

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar
Serial No.: 10/634,274
Filed: August 5, 2003
Title: H2 PLASMA TREATMENT

Examiner: Brook Kebede
Group Art Unit: 2823
Docket: 1303.110US1

COMMUNICATION CONCERNING RELATED APPLICATION

MS RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date/Issue Date</u>	<u>Attorney Docket</u>	<u>Title</u>
11458195	July 18, 2006	303.664US6	STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

PAUL A. FARRAR

By Applicant's Representatives,

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Date 18 December 2006 By David R. Cochran
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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 18 day of December, 2006.

USA Recorder
Name

Susan R. Recorder
Signature